

DESCRIPTION

The UP6206 series are a highly precise, lower consumption, 3 terminals, positive voltage regulators manufactured using CMOS and laser trimming technologies. The series provides large currents with a significantly small dropout voltage. The UP6206 consists of a current limiter circuit, a driver transistor, a precision reference voltage and an error correction circuit. The series is compatible with low ESR ceramic capacitors. The current limiter's foldback circuit operates as a short circuit protection as well as the output current limiter for the output pin. Output voltages are internally by laser trimming technologies. It is selectable in 0.1V increments within a range of 1.2V to 5.0V. UP6206 series are available in SOT23, DFN packages

300mA Low Power CMOS LDO

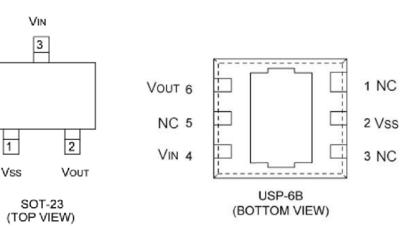
■ FEATURE

- Low power consumption
- Low voltage drop
- Low temperature coefficient
- Quiescent current 8uA at 6V
- High output current 300mA
- Output voltage accuracy: tolerance 2%
- SOT23, DFN2X2 packages

APPLICATIONS

- Battery-powered equipment
- Communication equipment
- Audio/Video equipmetn

PIN CONFIGURATION







■ PART NUMBER INFORMATION

UP6206-1)234	 (1) (2)=Output Voltage 1.2V ~ 5.0V
	③=Output Voltage Accuracy 1=1%, 2=2%
	④=Package Code S=SOT23 D=DFN

ORDERING INFROMATION

Part Number	Output Voltage	Package	Marking	
UP6206-332S	3.3	SOT23	3000EA / T&R	
UP6206-332D	3.3	DFN2X2	3000EA / T&R	

• **ABSOLUTE MAXIMUM RATINGS** ($T_A = 25 \mathcal{C}$ Unless otherwise noted)

Symbol	Parameter	Typical	Unit
VIN(MAX)	Supply Voltage	8	V
Іоит	Output Current	300	mA
Vout	Output Voltage	Vss-0.3~VIN+0.3	
TJ	Operation Junction Temperature	150	°C
Tstg	Storage Temperature Range -55~+150		°C
TOPR	Operation Temperature	-40~+80	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress rating only and functional device operation is not implied

THERMAL DATA

Symbol	Parameter	Package	Max	Unit
D-	D Dower Dissinction		0.2	W
PD	Power Dissipation	DFN2X2	0.5	W

UP6206 Rev B 28/July/2016



■ ELECTRICAL CHARACTERISTICS(T_A=25 °C Unless otherwise noted)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
Vin	Input Voltage		1.8		8	V
Vout	Output Voltage	V _{IN} =V _{OUT} +1V Iou⊤=10mA	Vout*0.98		Vout*1.02	V
Ιουτ	Output Current Note1	VIN=VOUT+1V		300		mA
ΔVουτ	Load Regulation	V _{IN} =V _{OUT} +1V, 1mA≤I _{OUT} ≤80mA		15	30	mV
V _{DIF}	Dropout Voltage Note2	Refer to the next table				
Iss	Quiescent Current	No Load		8	15	uA
ΔVουτ/ΔVιν*Vουτ	Line Regulation	Vout+1V≤Vin≤6V, Iout=40mA			0.2	%V
Vout/(Ta*Vout)	Output Voltage Temperature Coefficiency	I _{ou⊤} =30mA 0°C≤T _A ≤70°C		100		Ppm/℃
PSRR	PSRR	F=1KHz V _{IN} =V _{OUT} +1V		50		dB
I _{SHORT}	Short Circuit Current	V _{IN} =V _{OUT} +1.5V V _{OUT} =V _{SS}		120		mA
I _{LIMIT}	Over Current Protection			500	550	mA

Note1: The deviation parameters V_{OUT} and I_{OUT} are defined as the difference between the maximum and minimum values obtained over the rated temperature range

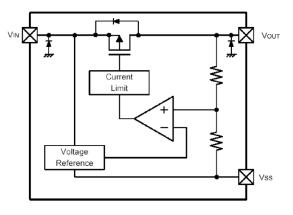
Note2: I_{OUT}=P_D/(V_{IN}-V_{OUT})

Electrical characteristics by Output Voltage

Output Voltage Vout (V)	Dropout Voltage Vdif (mV)			
	Conditions Typ Max			
Vouт≤1.5V		650	850	
1.8V≤V _{OUT} ≤2.5V	Iout=100mA	280	420	
2.5V≤V _{OUT} ≤5.0V		190	350	



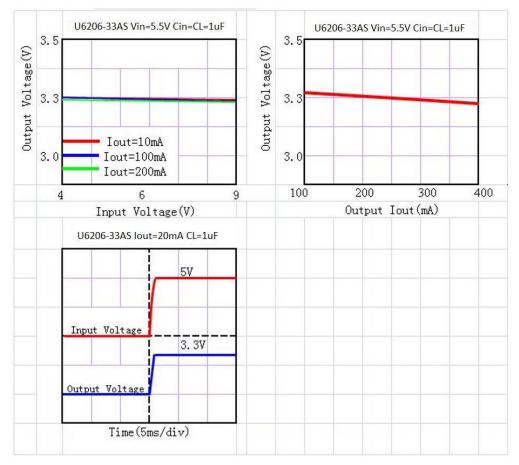
FUNCTION BLOCK DIAGRAM



*Diodes inside the circuit are an ESD protection diode and a parasitic diode.

TYPICAL PERFORMANCE CHARACTERISTICS($T_A=25 \ C$ Unless otherwise noted)

Output Voltage VS Input Voltage and Output Voltage VS Output Current and Input Transient Response

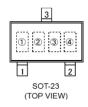






MARK RULE

SOT23



① Represents product number

╯.		
	Marking	Product series
	6	UP6206****

② Represents 3 pins regulator

Marł	Product series	
Voltage=1.2V~3.0V	Floduct series	
5	6	UP6206

③ Represents output voltage

Marking	Voltage (V)			Marking		Voltage (V)	
0		3.1		F	1.6	4.6	
1		3.2		Н	1.7	4.7	
2		3.3		K	1.8	4.8	
3		3.4		L	1.9	4.9	
4		3.5		М	2.0	5.0	
5		3.6		N	2.1		
6		3.7		Р	2.2		
7		3.8		R	2.3		
8		3.9		S	2.4		
9		4.0		Т	2.5		
A		4.1		U	2.6		
В	1.2	4.2		V	2.7		
С	1.3	4.3		Х	2.8		
D	1.4	4.4		Y	2.9		
E	1.5	4.5		Z	3.0		

Highlighted voltage is mass production

④ Represents production lot number

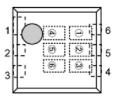
0 to 9, A to Z, and inverted 0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)





■ MARK RULE (continuous)

DFN1.8X2.0-6L



① ② Represents product number

Marking		Draduat agrica
1 2		Product series
0	6	UP6206-XX2D

③Represents 3 pins regulator

Marking	Product series
Р	UP6206-XXXD

(4)(5) Represents output voltage

Marking			Droduct acrica	
4	5	Voltage (V)	Product series	
3	3	3.3	UP6206-33XD	
5	0	5.0	UP6206-50XD	

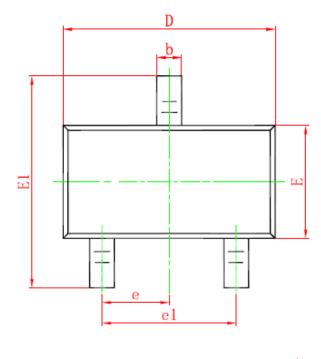
6 Represents production lot number

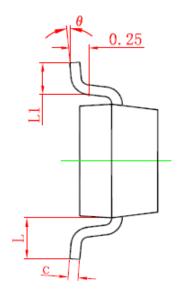
0 to 9, A to Z, and inverted 0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

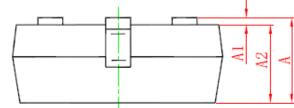




■ SOT23 PACKAGE OUTLINE DIMENSIONS







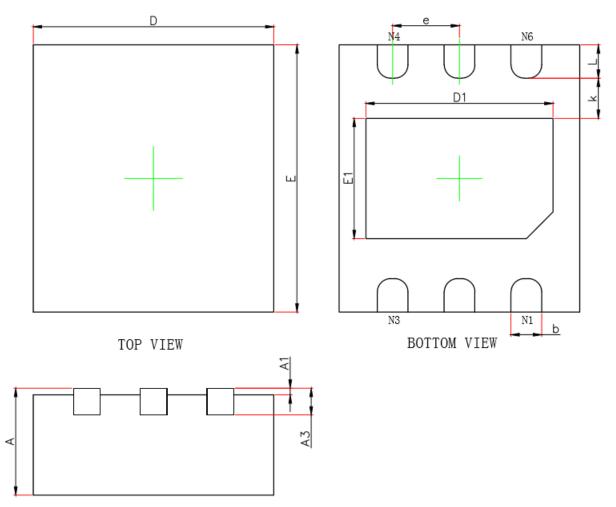
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

UP6206 Rev B 28/July/2016





■ DFN1.8X2-6L PACKAGE OUTLINE DIMENSIONS



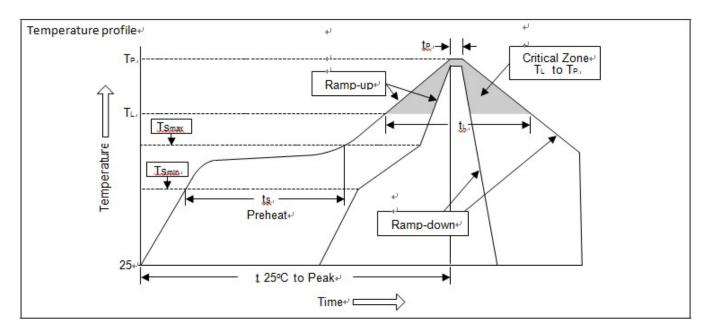
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.450/0.500/0.550	0.550/0.600/0.650	0.018/0.020/0.022	0.022/0.024/0.026
A1	0.000	0.050	0.000	0.002
A3	0.700	0.800		
A3	0.150REF.		0.006REF.	
D	1.724	1.876	0.068	0.074
E	1.924	2.076	0.076	0.082
D1	1.300	1.500	0.051	0.059
E1	0.800	1.000	0.031	0.039
k	0.200MIN.		0.008MIN.	
b	0.180	0.280	0.007	0.011
е	0.500TYP.		0.020TYP.	
L	0.174	0.326	0.007	0.013

UP6206 Rev B 28/July/2016



SOLDERING METHODS FOR UNIVERCHIP

Storage environment Temperature=10 $^\circ\!\mathrm{C}$ ~35 $^\circ\!\mathrm{C}$ Humidity=65%±15% Reflow soldering of surface mount device



Profile Feature	Sn-Pb Eutectic Assembly	Pb free Assembly	
Average ramp-up rate (T _L to T _P)	<3℃/sec	<3°C/sec	
Preheat			
-Temperature Min (Tsmin)	100 °C	150 ℃	
-Temperature Max (Ts _{max})	150 ℃	200 °C	
-Time (min to max) (ts)	60~120 sec	60~180 sec	
Tsmax to T∟	-2°0 /200	-2°C/2020	
-Ramp-up Rate	<3℃/sec	<3°C/sec	
Time maintained above			
-Temperature (T _L)	183 ℃	217 °C	
-Time (t∟)	60~150 sec	60~150 sec	
Peak Temperature (T _P)	240 ℃ +0/-5 ℃	260 ℃ +0/-5 ℃	
Time within 5°C of actual Peak	10, 20, 222	20~40 sec	
Temperature (t _P)	10~30 sec		
Ramp-down Rate	<6℃/sec	<6°C/sec	
Time 25 $^\circ\!\!\mathbb{C}$ to Peak Temperature	<6 minutes	<6 minutes	



Flow (wave) soldering (solder dipping)

Product	Peak Temperature	Dipping Time
Pb device	245℃±5℃	5sec±1sec
Pb-Free device	260℃+0/-5℃	5sec±1sec



This integrated circuit can be damaged by ESD UniverChip Corporation recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedure can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.